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March 2015

FDD306P
P-Channel 1.8V Specified PowerTrench® MOSFET

Features

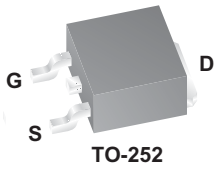
- –6.7 A, –12 V. $R_{DS(ON)}$ = 28 mΩ @ V_{GS} = –4.5 V
  $R_{DS(ON)}$ = 41 mΩ @ V_{GS} = –2.5 V
  $R_{DS(ON)}$ = 90 mΩ @ V_{GS} = –1.8 V
- Fast switching speed
- High performance trench technology for extremely low $R_{DS(ON)}$
- High power and current handling capability

Applications

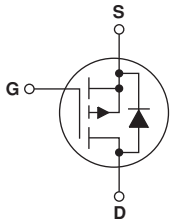
- DC/DC converter

General Description

This P-Channel 1.8V Specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management.



TO-252



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V_{DSS}	Drain-Source Voltage		–12	V
V_{GSS}	Gate-Source Voltage		±8	V
I_D	Drain Current – Continuous	(Note 3)	–6.7	A
	– Pulsed	(Note 1a)	–54	
P_D	Power Dissipation for Single Operation	(Note 1)	52	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T_J, T_{STG}	Operating and Storage Junction Temperature Range		–55 to +175	°C
Thermal Characteristics				
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.9	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDD306P	FDD306P	13”	16mm	2500 units

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Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain–Source Breakdown Voltage	V_{GS} = 0 V, I_D = –250 μA	–12			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = –250 μA, Referenced to 25°C		–0.6		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = –10 V, V_{GS} = 0 V			–1	μA
I_{GSSF}	Gate–Body Leakage	V_{GS} = ±8V, V_{DS} = 0 V			±100	nA
On Characteristics (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = –250 μA	–0.4	–0.5	–1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = –250 μA, Referenced to 25°C		2.2		mV/°C
$R_{DS(on)}$	Static Drain–Source On–Resistance	V_{GS} = –4.5 V, I_D = –6.7 A V_{GS} = –2.5 V, I_D = –6.1 A V_{GS} = –1.8 V, I_D = –4.8 A V_{GS} = –4.5 V, I_D = –6.7A, T_J = 125°C		21 29 42 25	28 41 90	mΩ
$I_{D(on)}$	On–State Drain Current	V_{GS} = –4.5 V, V_{DS} = –5 V	–45			A
g_{FS}	Forward Transconductance	V_{DS} = –5 V, I_D = –6.7 A		22		S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = –6 V, V_{GS} = 0 V, f = 1.0 MHz		1290		pF
C_{oss}	Output Capacitance			590		pF
C_{rss}	Reverse Transfer Capacitance			430		pF
R_G	Gate Resistance	V_{GS} = 15 mV, f = 1.0 MHz		4.2		Ω
Switching Characteristics (Note 2)						
$t_{d(on)}$	Turn–On Delay Time	V_{DD} = –6 V, I_D = –1 A, V_{GS} = –4.5 V, R_{GEN} = 6 Ω		16	29	ns
t_r	Turn–On Rise Time			8	16	ns
$t_{d(off)}$	Turn–Off Delay Time			34	54	ns
t_f	Turn–Off Fall Time			41	65	ns
Q_g	Total Gate Charge	V_{DS} = –6V, I_D = –6.7 A, V_{GS} = –4.5 V		15	21	nC
Q_{gs}	Gate–Source Charge			2.0		nC
Q_{gd}	Gate–Drain Charge			4.4		nC
Drain–Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain–Source Diode Forward Current				–3.2	A
V_{SD}	Drain–Source Diode Forward Voltage	V_{GS} = 0 V, I_S = –3.2 A (Note 2)		–0.8	–1.2	V
Trr	Diode Reverse Recovery Time	IF = –6.7 A, diF/dt = 100 A/μs (Note 3)		37		ns
Irm	Diode Reverse Recovery Current			0.9		A
Qrr	Diode Reverse Recovery Charge			17		nC

Notes:

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) $R_{\theta JA}$ = 40°C/W when mounted on a 1in^2 pad of 2 oz copper



b) $R_{\theta JA}$ = 96°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300μs, Duty Cycle < 2.0%

3. Maximum current is calculated as: $\sqrt{\frac{P_D}{R_{DS(ON)}}}$ where P_D is maximum power dissipation at T_C = 25°C and $R_{DS(on)}$ is at $T_{J(max)}$ and V_{GS} = 10V.

4. Starting T_J = 25°C, L = 3 mH, I_{AS} = -4 A, V_{GS} = -10 V, V_{DD} = -12 V.

Typical Characteristics

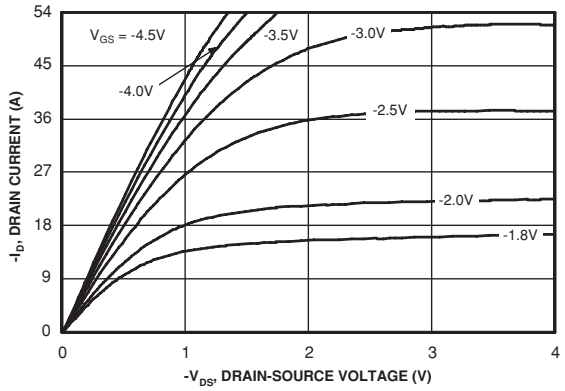


Figure 1. On-Region Characteristics.

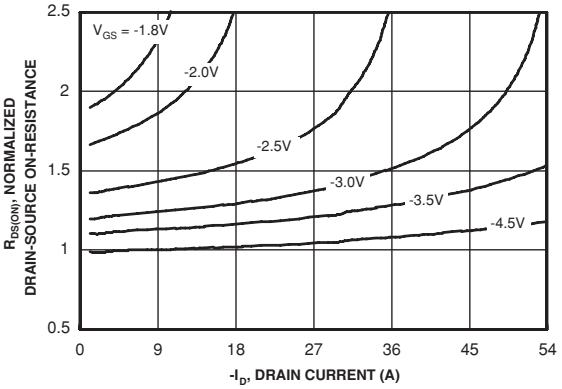


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

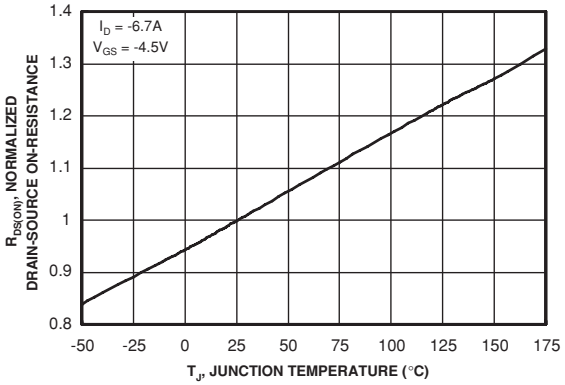


Figure 3. On-Resistance Variation withTemperature.

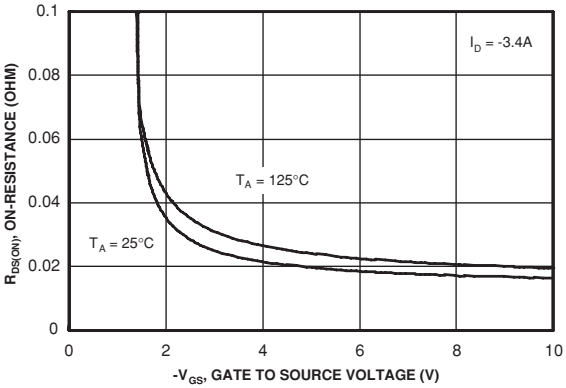


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

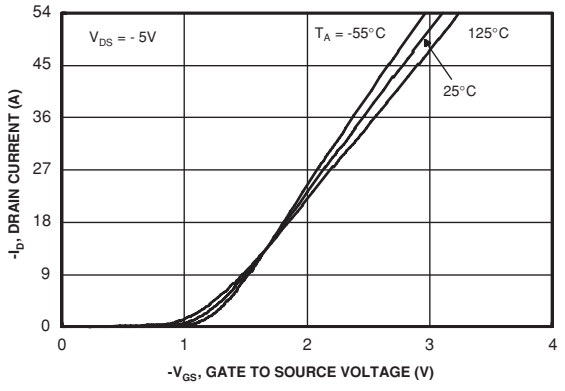


Figure 5. Transfer Characteristics.

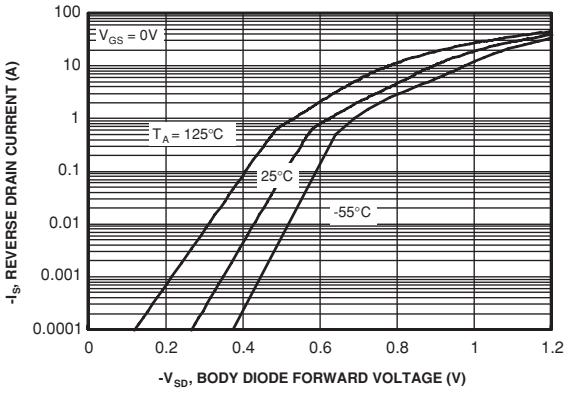


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics

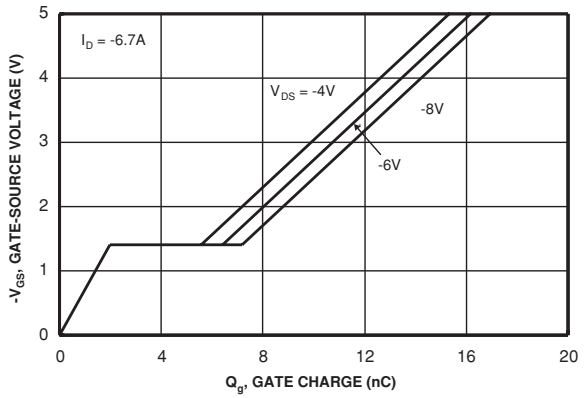


Figure 7. Gate Charge Characteristics.

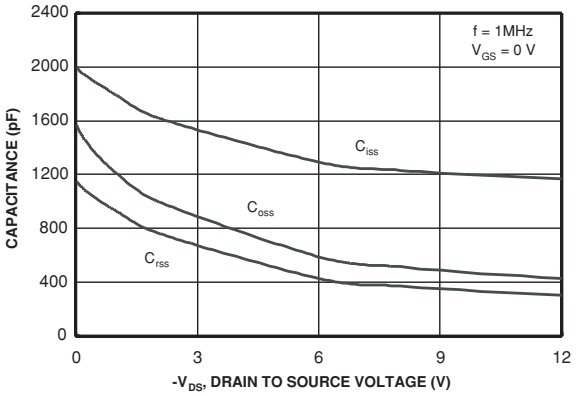


Figure 8. Capacitance Characteristics.

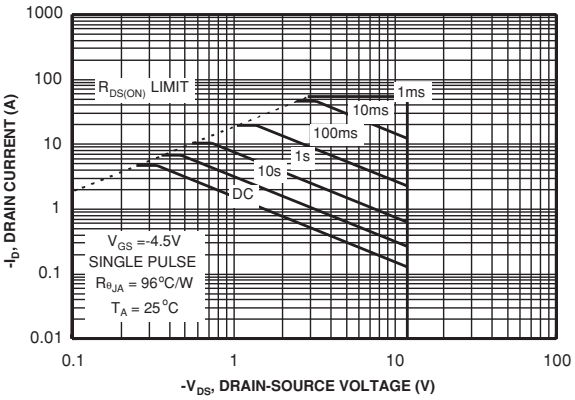


Figure 9. Maximum Safe Operating Area.

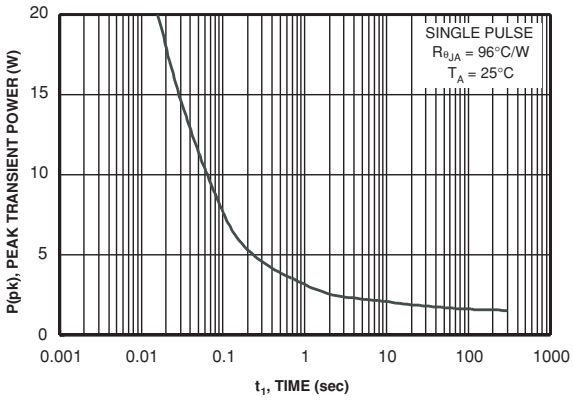


Figure 10. Single Pulse Maximum Power Dissipation.

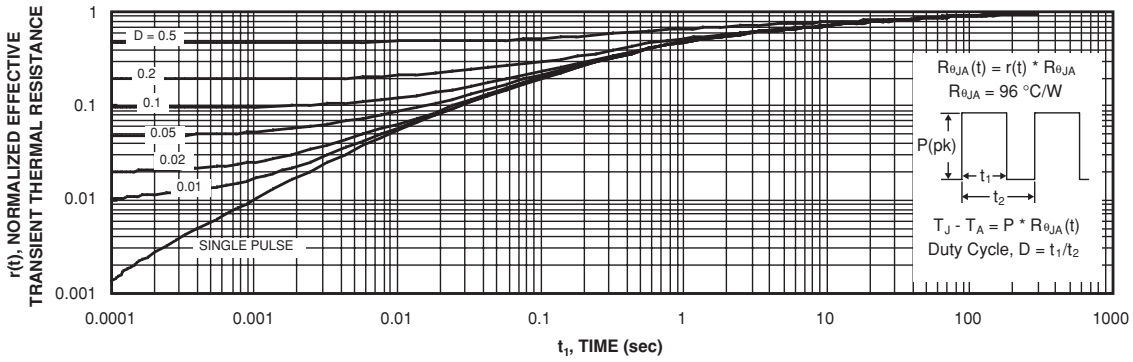
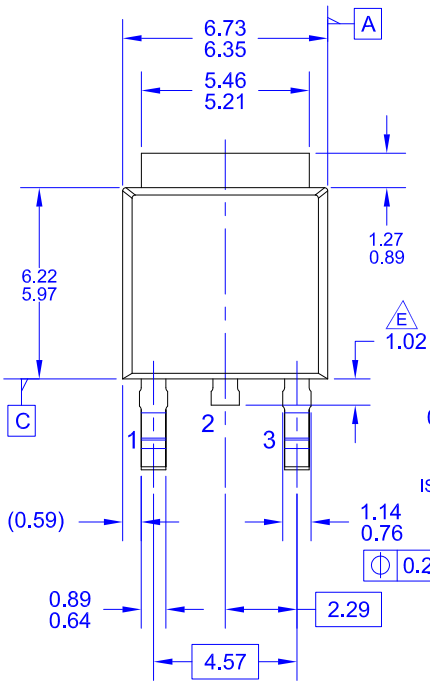
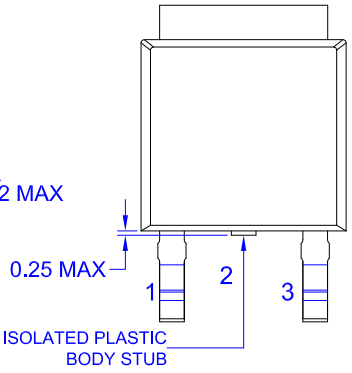


Figure 11. Transient Thermal Response Curve.

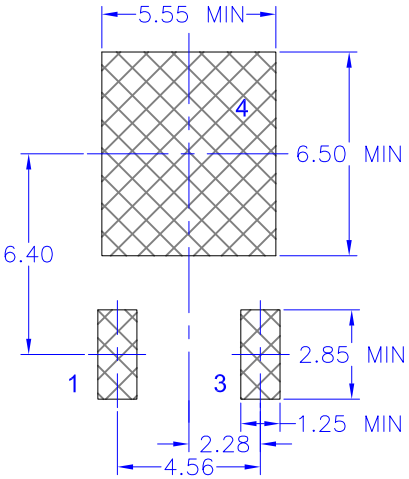
Thermal characterization performed using the conditions described in Note 1c.
Transient thermal response will change depending on the circuit board design.



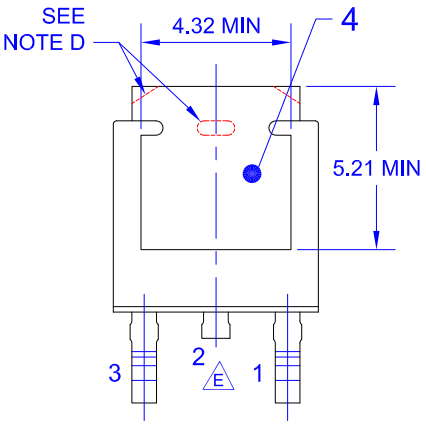
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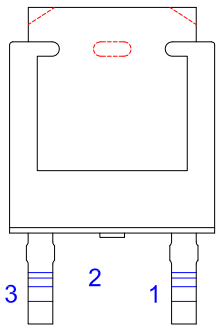
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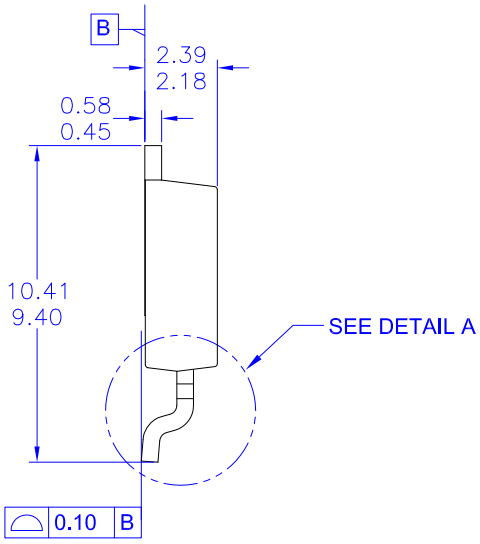
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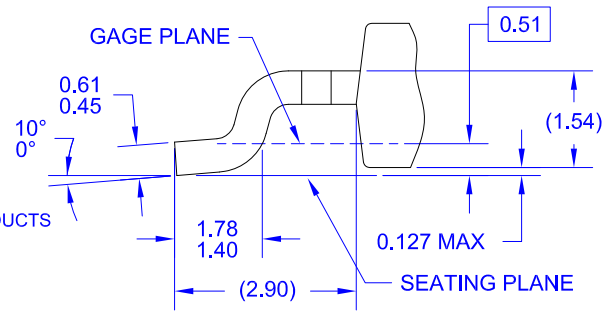


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E) TRIMMED METAL CENTER LEAD IS PRESENT ON FOR NON-DIODE PRODUCTS
F) DIMENSIONS ARE EXCLUSIVE OF BURS, MOLD FLASH AND TIE BAR EXTRUSIONS.
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H) DRAWING NUMBER AND REVISION: MKT-TO252A03REV11



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